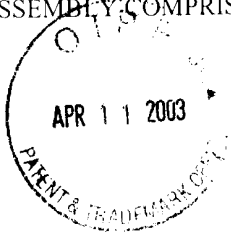


Applicant: Biswajit Sur et al.
Title: ELECTRONIC ASSEMBLY COMPRISING SOLDERABLE THERMAL INTERFACE (As Amended)
Docket No.: 884.319US1
Filed: August 31, 2000
Examiner: Andy Huynh

Serial No.: 09/652430
Due Date: May 3, 2003
Group Art Unit: 2818

**BOX AF**

Commissioner for Patents
Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

- ☒ A return postcard.
☒ An Amendment and Response Under 37 C.F.R. 1.116 (13 Pages).

If not provided for in a separate paper filed herewith, Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.
P.O. Box 2938, Minneapolis, MN 55402 (612-373-6900)

By: Ann M. McCrackin
Atty: Ann M. McCrackin
Reg. No. 42,858

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: BOX AF, Commissioner for Patents, Washington, D.C. 20231, on this 3rd day of April, 2003.

Anne M. Richards
Name

Ann M. McCrackin
Signature

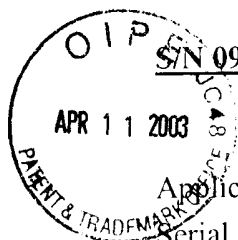
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EXPEDITED PROCEDURE - EXAMINING GROUP 2818



S/N 09/652,430

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Biswajit Sur et al.

Examiner: Andy Huynh

Serial No.: 09/652,430

Group Art Unit: 2818

Filed: August 31, 2000

Docket No.: 884.319US1

Title: ELECTRONIC ASSEMBLY COMPRISING SOLDERABLE THERMAL
INTERFACE

AMENDMENT & RESPONSE UNDER 37 C.F.R. § 1.116

Box AF
Commissioner for Patents
Washington, D.C. 20231

In response to the final Office Action mailed February 3, 2003, please amend the application as follows. The amendments are made in the "revised amendment format" announced by the Deputy Commissioner for Patent Examination Policy on January 31, 2003.

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